

# MC74LVX373MG Datasheet





DiGi Electronics Part Number

A PROVING

onsemi

Manufacturer Product Number

Description

Manufacturer

**Detailed Description** 

MC74LVX373MG

MC74LVX373MG-DG

IC DTYPE TRANSP SGL 8:8 20SOEIAJ

D-Type Transparent Latch 1 Channel 8:8 IC Tri-Stat e SOEIAJ-20

https://www.DiGi-Electronics.com



Tel: +00 852-30501935

RFQ Email: Info@DiGi-Electronics.com

DiGi is a global authorized distributor of electronic components.



## Purchase and inquiry

Manufacturer Product Number:	Manufacturer:
MC74LVX373MG	onsemi
Series:	Product Status:
74LVX	Obsolete
Logic Type:	Circuit:
D-Type Transparent Latch	8:8
Output Type:	Voltage - Supply:
Tri-State	2V ~ 3.6V
Independent Circuits:	Delay Time - Propagation:
1	5.8ns
Current - Output High, Low:	Operating Temperature:
4mA, 4mA	-40°C ~ 85°C
Mounting Type:	Package / Case:
Surface Mount	20-SOIC (0.209", 5.30mm Width)
Supplier Device Package:	Base Product Number:
SOEIAJ-20	74LVX373

## **Environmental & Export classification**

Moisture Sensitivity Level (MSL):	REACH Status:
3 (168 Hours)	REACH Unaffected
ECCN:	HTSUS:
EAR99	8542.39.0001

# onsemi

# Octal D-Type Latch with 3-State Outputs

With 5V–Tolerant Inputs

# MC74LVX373

The MC74LVX373 is an advanced high speed CMOS octal latch with 3-state outputs. The inputs tolerate voltages up to 7.0 V, allowing the interface of 5.0 V systems to 3.0 V systems.

This 8-bit D-type latch is controlled by a latch enable input and an output enable input. When the output enable input is high, the eight outputs are in a high impedance state.

#### Features

- High Speed:  $t_{PD} = 5.8 \text{ ns} (Typ) \text{ at } V_{CC} = 3.3 \text{ V}$
- Low Power Dissipation:  $I_{CC} = 4 \mu A$  (Max) at  $T_A = 25^{\circ}C$
- Power Down Protection Provided on Inputs
- Balanced Propagation Delays
- Low Noise:  $V_{OLP} = 0.8 V (Max)$
- Pin and Function Compatible with Other Standard Logic Families
- Latchup Performance Exceeds 300 mA
- ESD Performance:

Human Body Model > 2000 V; Machine Model > 200 V

• These Devices are Pb-Free and are RoHS Compliant

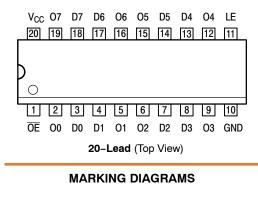


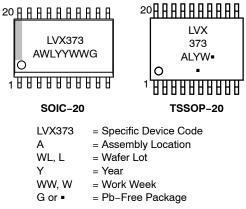


SOIC-20 DW SUFFIX CASE 751D



#### **PIN ASSIGNMENT**





(Note: Microdot may be in either location)

#### PIN NAMES

Pins	Function
OE LE D0-D7	Output Enable Input Latch Enable Input Data Inputs
00-07	3-State Latch Outputs

#### **ORDERING INFORMATION**

See detailed ordering and shipping information in the package dimensions section on page 5 of this data sheet.

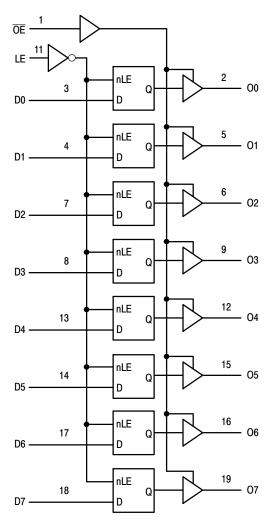


Figure 1. Logic Diagram

	INPUTS		OUTPUTS	
ŌĒ	LE	Dn	On	OPERATING MODE
L	H H	ΤL	H L	Transparent (Latch Disabled); Read Latch
L	L L	h I	H L	Latched (Latch Enabled) Read Latch
L	L	Х	NC	Hold; Read Latch
Н	L	Х	Z	Hold; Disabled Outputs
H H	H H	ΤL	Z Z	Transparent (Latch Disabled); Disabled Out- puts
H H	L	h I	Z Z	Latched (Latch Enabled); Disabled Outputs

H = High Voltage Level; h = High Voltage Level One Setup Time Prior to the Latch Enable High-to-Low Transition; L = Low Voltage Level; I = Low Voltage Level One Setup Time Prior to the Latch Enable High-to-Low Transition; NC = No Change, State Prior to the Latch Enable High-to-Low Transition; X = High or Low Voltage Level or Transitions are Acceptable; Z = High Impedance State; For I<sub>CC</sub> Reasons DO NOT FLOAT Inputs

#### MAXIMUM RATINGS

Symbol	Parameter	Value	Unit
V <sub>CC</sub>	DC Supply Voltage	–0.5 to +7.0	V
V <sub>in</sub>	DC Input Voltage	-0.5 to +7.0	V
V <sub>out</sub>	DC Output Voltage	–0.5 to V <sub>CC</sub> +0.5	V
Ι <sub>ΙΚ</sub>	Input Diode Current	-20	mA
Ι <sub>ΟΚ</sub>	Output Diode Current	±20	mA
I <sub>out</sub>	DC Output Current, per Pin	±25	mA
I <sub>CC</sub>	DC Supply Current, $V_{CC}$ and GND Pins	±75	mA
PD	Power Dissipation	180	mW
T <sub>stg</sub>	Storage Temperature	–65 to +150	°C

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

#### **RECOMMENDED OPERATING CONDITIONS**

Symbol	Parameter	Min	Max	Unit
V <sub>CC</sub>	DC Supply Voltage	2.0	3.6	V
V <sub>in</sub>	DC Input Voltage	0	5.5	V
V <sub>out</sub>	DC Output Voltage	0	V <sub>CC</sub>	V
T <sub>A</sub>	Operating Temperature, All Package Types	-40	+85	°C
$\Delta t/\Delta V$	Input Rise and Fall Time	0	100	ns/V

Functional operation above the stresses listed in the Recommended Operating Ranges is not implied. Extended exposure to stresses beyond the Recommended Operating Ranges limits may affect device reliability.

#### DC ELECTRICAL CHARACTERISTICS

			v <sub>cc</sub>	Т	A = 25°	С	T <sub>A</sub> = -40	to 85°C	
Symbol	Parameter	Test Conditions	v	Min	Тур	Max	Min	Max	Unit
V <sub>IH</sub>	High-Level Input Voltage		2.0 3.0 3.6	1.5 2.0 2.4			1.5 2.0 2.4		V
VIL	Low-Level Input Voltage		2.0 3.0 3.6			0.5 0.8 0.8		0.5 0.8 0.8	V
V <sub>OH</sub>	High-Level Output Voltage (V <sub>in</sub> = V <sub>IH</sub> or V <sub>IL</sub> )	$I_{OH} = -50 \ \mu A$ $I_{OH} = -50 \ \mu A$ $I_{OH} = -4 \ m A$	2.0 3.0 3.0	1.9 2.9 2.58	2.0 3.0		1.9 2.9 2.48		V
V <sub>OL</sub>	Low-Level Output Voltage (V <sub>in</sub> = V <sub>IH</sub> or V <sub>IL</sub> )	$I_{OL} = 50 \ \mu A$ $I_{OL} = 50 \ \mu A$ $I_{OL} = 4 \ m A$	2.0 3.0 3.0		0.0 0.0	0.1 0.1 0.36		0.1 0.1 0.44	V
l <sub>in</sub>	Input Leakage Current	V <sub>in</sub> = 5.5 V or GND	3.6			±0.1		±1.0	μΑ
I <sub>OZ</sub>	Maximum 3-State Leakage Current	$V_{in} = V_{IL} \text{ or } V_{IH}$ $V_{out} = V_{CC} \text{ or } GND$	3.6			±0.2 5		±2.5	μΑ
I <sub>CC</sub>	Quiescent Supply Current	$V_{in} = V_{CC}$ or GND	3.6			4.0		40.0	μΑ

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions.

AC ELECTRICAL CHARACTERISTICS	(Input t <sub>r</sub> = t <sub>f</sub> = 3.0ns)
-------------------------------	---

						С	T <sub>A</sub> = -40	to 85°C	
Symbol	Parameter	Test Con	ditions	Min	Тур	Max	Min	Max	Unit
t <sub>PLH</sub> , t <sub>PHL</sub>	Propagation Delay D to O	V <sub>CC</sub> = 2.7 V	C <sub>L</sub> = 15 pF C <sub>L</sub> = 50 pF		7.5 10.0	14.5 18.0	1.0 1.0	17.5 21.0	ns
		$V_{CC} = 3.3 \pm 0.3 V$	C <sub>L</sub> = 15 pF C <sub>L</sub> = 50 pF		5.8 8.3	9.3 12.8	1.0 1.0	11.0 14.5	
t <sub>PLH</sub> , t <sub>PHL</sub>	Propagation Delay LE to O	V <sub>CC</sub> = 2.7 V	C <sub>L</sub> = 15 pF C <sub>L</sub> = 50 pF		7.7 10.2	15.0 18.5	1.0 1.0	18.5 22.0	ns
		$V_{CC} = 3.3 \pm 0.3 V$	C <sub>L</sub> = 15 pF C <sub>L</sub> = 50 pF		6.0 8.5	9.7 13.2	1.0 1.0	11.5 15.0	
t <sub>PZL</sub> , t <sub>PZH</sub>	Output Enable Time OE to O	$V_{CC}$ = 2.7 V R <sub>L</sub> = 1 k $\Omega$	C <sub>L</sub> = 15 pF C <sub>L</sub> = 50 pF		7.7 10.2	15.0 18.5	1.0 1.0	18.5 22.0	ns
		$V_{CC} = 3.3 \pm 0.3 \text{ V}$ $R_{L} = 1 \text{ k}\Omega$	C <sub>L</sub> = 15 pF C <sub>L</sub> = 50 pF		6.0 8.5	9.7 13.2	1.0 1.0	11.5 15.0	
t <sub>PLZ</sub> , t <sub>PHZ</sub>	Output Disable Time OE to O	$V_{CC}$ = 2.7 V R <sub>L</sub> = 1 k $\Omega$	C <sub>L</sub> = 50 pF		9.8	18.0	1.0	21.0	ns
		$V_{CC} = 3.3 \pm 0.3 \text{ V}$ $R_L = 1 \text{ k}\Omega$	C <sub>L</sub> = 50 pF		8.2	12.8	1.0	14.5	
t <sub>OSHL</sub> t <sub>OSLH</sub>	Output-to-Output Skew (Note 1)	V <sub>CC</sub> = 2.7 V V <sub>CC</sub> = 3.3 ±0.3 V	- ·			1.5 1.5		1.5 1.5	ns

 Skew is defined as the absolute value of the difference between the actual propagation delay for any two separate outputs of the same device. The specification applies to any outputs switching in the same direction, either HIGH-to-LOW (t<sub>OSHL</sub>) or LOW-to-HIGH (t<sub>OSLH</sub>); parameter guaranteed by design.

#### **CAPACITIVE CHARACTERISTICS**

		Т	T <sub>A</sub> = 25°C		T <sub>A</sub> = −40 to 85°C		
Symbol	Parameter	Min	Тур	Max	Min	Max	Unit
Cin	Input Capacitance		4	10		10	pF
C <sub>out</sub>	Maximum Three-State Output Capacitance		6				pF
C <sub>PD</sub>	Power Dissipation Capacitance (Note 2)		27				pF

2.  $C_{PD}$  is defined as the value of the internal equivalent capacitance which is calculated from the operating current consumption without load. Average operating current can be obtained by the equation:  $I_{CC(OPR)} = C_{PD} \bullet V_{CC} \bullet f_{in} + I_{CC}/8$  (per latch).  $C_{PD}$  is used to determine the no-load dynamic power consumption;  $P_D = C_{PD} \bullet V_{CC}^2 \bullet f_{in} + I_{CC} \bullet V_{CC}$ .

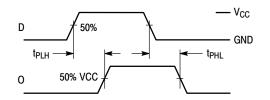
#### **NOISE CHARACTERISTICS** (Input $t_r = t_f = 3.0$ ns, $C_L = 50$ pF, $V_{CC} = 3.3$ V, Measured in SOIC Package)

		<b>T</b> <sub>A</sub> = 1	T <sub>A</sub> = 25°C	
Symbol	Characteristic	Тур	Max	Unit
V <sub>OLP</sub>	Quiet Output Maximum Dynamic V <sub>OL</sub>	0.5	0.8	V
V <sub>OLV</sub>	Quiet Output Minimum Dynamic V <sub>OL</sub>	-0.5	-0.8	V
V <sub>IHD</sub>	Minimum High Level Dynamic Input Voltage		2.0	V
V <sub>ILD</sub>	Maximum Low Level Dynamic Input Voltage		0.8	V

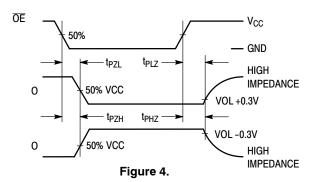
#### TIMING REQUIREMENTS (Input t<sub>r</sub> = t<sub>f</sub> = 3.0ns)

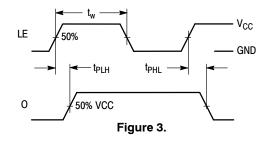
			T <sub>A</sub> = 25°C		T <sub>A</sub> = 25°C		T <sub>A</sub> = 25°C		T <sub>A</sub> = 25°C		T <sub>A</sub> = 25°C		T <sub>A</sub> = 25°C		T <sub>A</sub> = 25°C		T <sub>A</sub> = 25°C		T <sub>A</sub> = 25°C		T <sub>A</sub> = −40 to 85°C	
Symbol	Parameter	Test Conditions	Тур	Limit	Limit	Unit																
t <sub>w(h)</sub>	Minimum Pulse Width, LE	$V_{CC} = 2.7 V$ $V_{CC} = 3.3 \pm 0.3 V$		6.5 5.0	7.5 5.0	ns																
t <sub>su</sub>	Minimum Setup Time, D to LE	$V_{CC} = 2.7V$ $V_{CC} = 3.3 \pm 0.3 V$		6.0 4.0	6.0 4.0	ns																
t <sub>h</sub>	Minimum Hold Time, D to LE	$V_{CC} = 2.7 V$ $V_{CC} = 3.3 \pm 0.3 V$		1.0 1.0	1.0 1.0	ns																

#### SWITCHING WAVEFORMS









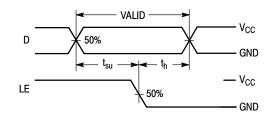
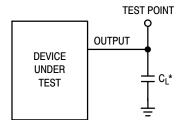


Figure 5.

#### **TEST CIRCUITS**



\*Includes all probe and jig capacitance Figure 6. Propagation Delay Test Circuit

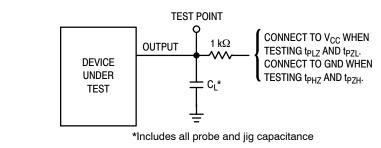


Figure 7. Three-State Test Circuit

#### **ORDERING INFORMATION**

Device	Package	Shipping <sup>†</sup>
MC74LVX373DWR2G	SOIC-20 (Pb-Free)	1000 Tape & Reel
MC74LVX373DTR2G	TSSOP-20 (Pb-Free)	2500 Tape & Reel

+For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, <u>BRD8011/D.</u>

SOIC-20 WB CASE 751D-05



H

H R

> Н Н Н Н

20X b  $\oplus$ 

18X e

20X 0.52 🖛

A

20

D

P

'H

H H H

Н

0.25 M T A S B S

RECOMMENDED

SOLDERING FOOTPRINT\*

П

11

Ε

B

Α

Δ1 Ť

SEATING PLANE

20X

1.30

11.00

10

DIMENSIONS: MILLIMETERS

1.27

\*For additional information on our Pb-Free strategy and soldering details, please download the **onsemi** Soldering and Mounting

Techniques Reference Manual, SOLDERRM/D.

PITCH

# **MECHANICAL CASE OUTLINE**

PACKAGE DIMENSIONS



SCALE 1:1

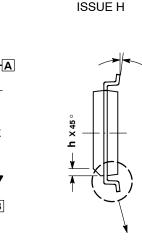
B

3

0.25

 $\oplus$ 

т





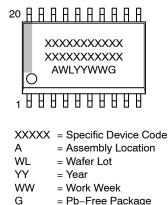
DATE 22 APR 2015

NOTES:

- 1. DIMENSIONS ARE IN MILLIMETERS. 2. INTERPRET DIMENSIONS AND TOLERANCES
- PER ASME Y14.5M, 1994. 3. DIMENSIONS D AND E DO NOT INCLUDE MOLD PROTRUSION. MAXIMUM MOLD PROTRUSION 0.15 PER SIDE.
- 4. DIMENSION B DOES NOT INCLUDE DAMBAR PROTRUSION. ALLOWABLE PROTRUSION 5. SHALL BE 0.13 TOTAL IN EXCESS OF B DIMENSION AT MAXIMUM MATERIAL CONDITION.

	MILLIMETERS	
DIM	MIN	MAX
Α	2.35	2.65
A1	0.10	0.25
b	0.35	0.49
C	0.23	0.32
D	12.65	12.95
E	7.40	7.60
е	1.27 BSC	
H	10.05	10.55
h	0.25	0.75
L	0.50	0.90
θ	0 °	7 °

GENERIC **MARKING DIAGRAM\*** 



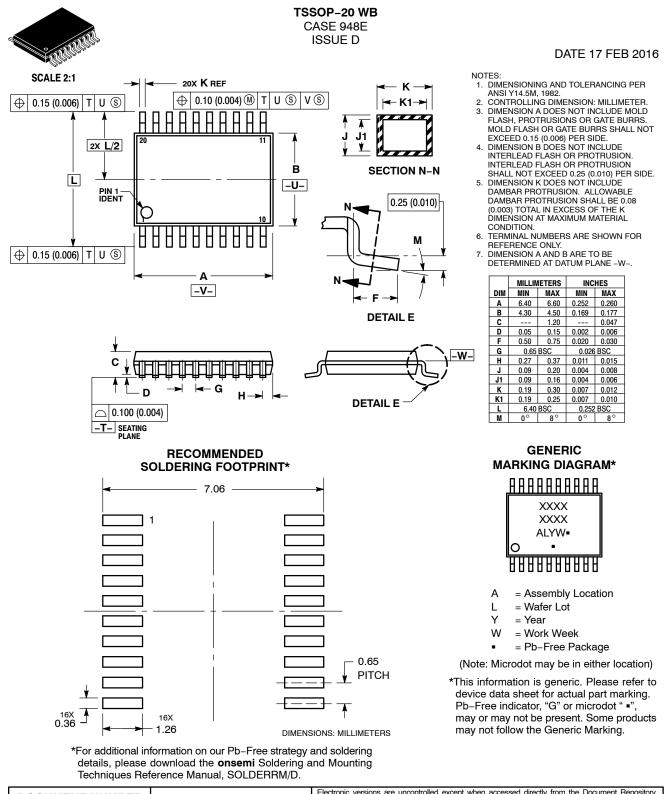
\*This information is generic. Please refer to device data sheet for actual part marking. Pb-Free indicator, "G" or microdot "•", may or may not be present. Some products may not follow the Generic Marking.

DOCUMENT NUMBER:	98ASB42343B	Electronic versions are uncontrolled except when accessed directly from Printed versions are uncontrolled except when stamped "CONTROLLED 0	
DESCRIPTION:	SOIC-20 WB		PAGE 1 OF 1
the right to make changes without furth purpose, nor does <b>onsemi</b> assume an	er notice to any products herein. <b>onsemi</b> make ny liability arising out of the application or use	LLC dba <b>onsemi</b> or its subsidiaries in the United States and/or other cour es no warranty, representation or guarantee regarding the suitability of its pr of any product or circuit, and specifically disclaims any and all liability, inc e under its patent rights nor the rights of others.	roducts for any particular



## **MECHANICAL CASE OUTLINE**

PACKAGE DIMENSIONS



DOCUMENT NUMBER:	98ASH70169A Electronic versions are uncontrolled except when accessed directly from the Document Repository Printed versions are uncontrolled except when stamped "CONTROLLED COPY" in red.		
DESCRIPTION:	TSSOP-20 WB		PAGE 1 OF 1

onsemi and ONSEMi are trademarks of Semiconductor Components Industries, LLC dba onsemi or its subsidiaries in the United States and/or other countries. onsemi reserves the right to make changes without further notice to any products herein. **onsemi** makes no warranty, representation or guarantee regarding the suitability of its products for any particular purpose, nor does **onsemi** assume any liability arising out of the application or use of any product or circuit, and specifically disclaims any and all liability, including without limitation special, consequential or incidental damages. onsemi does not convey any license under its patent rights nor the rights of others.

onsemi, ONSEMI, and other names, marks, and brands are registered and/or common law trademarks of Semiconductor Components Industries, LLC dba "onsemi" or its affiliates and/or subsidiaries in the United States and/or other countries. onsemi owns the rights to a number of patents, trademarks, copyrights, trade secrets, and other intellectual property. A listing of onsemi's product/patent coverage may be accessed at <u>www.onsemi.com/site/pdf/Patent-Marking.pdf</u>. onsemi reserves the right to make changes at any time to any products or information herein, without notice. The information herein is provided "as-is" and onsemi makes no warranty, representation or guarantee regarding the accuracy of the information, product features, availability, functionality, or suitability of its products for any particular purpose, nor does onsemi assume any liability arising out of the application or use of any product or circuit, and specifically disclaims any and all liability, including without limitation special, consequential or incidental damages. Buyer is responsible for its products and applications using onsemi products, including compliance with all laws, regulations and safety requirements or standards, regardless of any support or applications information provided by onsemi. "Typical" parameters which may be provided in onsemi data sheets and/or specifications can and do vary in different applications and actual performance may vary over time. All operating parameters, including "Typicals" must be validated for each customer application by customer's technical experts. onsemi does not convey any license under any of its intellectual property rights nor the rights of others. onsemi products are not designed, intended, or authorized for use as a critical component in life support systems or any FDA Class 3 medical devices or medical devices with a same or similar classification in a foreign jurisdiction or any devices intended for implantation in the human body. Should Buyer purchase or use onsemi products for any such

#### ADDITIONAL INFORMATION

TECHNICAL PUBLICATIONS:

Technical Library: www.onsemi.com/design/resources/technical-documentation onsemi Website: www.onsemi.com

ONLINE SUPPORT: www.onsemi.com/support For additional information, please contact your local Sales Representative at www.onsemi.com/support/sales



### **OUR CERTIFICATE**

DiGi provide top-quality products and perfect service for customer worldwide through standardization, technological innovation and continuous improvement. DiGi through third-party certification, we striciy control the quality of products and services. Welcome your RFQ to Email: Info@DiGi-Electronics.com

	<section-header></section-header>		
Marginary Marginary   Marginary	Market	Marchine Marchine Image: Control of the sector of the sec	





Tel: +00 852-30501935

RFQ Email: Info@DiGi-Electronics.com

DiGi is a global authorized distributor of electronic components.